Standardized Information for Process/Product Change Notification (PCN)

	1. PCI	N basic data	Form	
1.1 Company TAIWAN SEMICONDUCTOR	TAIWAN SEMICONDUCTOR CO., LTD			
1.2 PCN No.	QPCN15012	QPCN15012		
1.3 Title of PCN	Assembly site change	Assembly site change for O/J process and package A-405		
1.4 Product Category	Semiconductor compo	Semiconductor components		
1.5 Issue date	2015/07/30	2015/07/30		
1.6 PCN revision history (optional)	1.7 Issue date of previous revision (optional)	1.8 Delta to previous revision (optional)	1.8c	

2. PCN Team						
2.1 Contact supplier						
2.1.1 Name	Demi_Kao					
2.1.2 Phone	+886 2 8913 1588 ext. 2202					
2.1.3 Email	Demi_Kao@mail.ts.com.tw					
2.2 Team supplier (optional)						
2.2.1 Name (optional)	2.2.2 Phone (optional)	2.2.3 Email (optional)				
Kimi Lin	+886 2 8913-1588 Ext. 2126	Kimi@mail.ts.com.tw				
Owen Wang	+886 2 8913-1588 Ext. 2201	Owen@mail.ts.com.tw				

3. Changes						
	3.1 Category	3.2 Type of change				
Change #1	Process - Assembly	Move of all or part of assembly to a not previously released location/site/subcontractor				
Change #2						
Change #3						
Change #4						
Change #5						

4. Description of change						
	Old		New			
Change #1	Homemade located in 0	China	Outsourcing	g located in China		
Change #2						
Change #3						
Change #4						
Change #5						
4.6 Anticipated impact on form, fit, function, reliability or processability?	None					
4.7 Reference parts with customer number (optional)						
	5. Reason / motiv	etion for cha	nge			
5.1 Motivation	production site change fro			g		
5.2 Additional explanation (optional)						
	C. Marking of porto /	bility of	- hange			
6.1 Description	6. Marking of parts / t	raceability of	change			
7.1 Date of qualification results	7. Timing / 2015/07/30	schedule				
		<u> </u>				
7.2 Last order date (optional)	2015/10/30	<u> </u>				
7.3 Last delivery date (optional)	2016/08/01					
7.4 Intended start of delivery	2015/10/30					
7.5 Qualification samples available?						
	2015/07/30					
7.6 Customer feedback required until	2015/08/30					
	8. Qualification	on / validation				
8.1 Description (e.g. qual. plan/report, AEC-Q)	According to JESD					
8.2 Qualification report and qualification results	available (see attachement) issue					
	9. Input to customer for r	rick accessm	ont process			
	3. Input to customer ic	ISK assessi	ent process			
10. Attachments (e.g. new	datasheet, additional doc	umentation, p	pictures, proc	ess flow, sample pla	an,)	
see attached involved part number list. QPCN15012_Involved P.N						

11. Affected parts									
11.1 Current					11.2 New (if applicable)				
11.1.1 Customer Part No.	11.1.2 Supplier Part Name	11.1.3 Supplier Part No. (optional)	11.1.4 Package Name	11.1.5 Part Descriptio n (optional)	Additional	11.2.2 Supplier Part Name	11.2.3 Supplier Part No. (optional)	11.2.4 Package Name	11.2.6 Additional Part Information (optional)
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